

#### Spark Assisted Chemical Engraving (SACE)

An innovative technology with high potential for industry

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#### **Our Mission**

Develop green advanced manufacturing technologies meeting the demand of the fourth industrial revolution





## **Our Expertise**

#### Glass Machining



- Lab-on-Chip
- Multilayer chips
- Micro- to Macro-world interfaces

#### Post-Processing



- Multiscale electro-polishing
- Down to Ra of 50nm
- Broad range of materials including Titanium



- Complex parts
- Wide range of substrate materials
- Tuning surface wettability

#### Industry 4.0



- Batch Size 1 production
- Internet of Things (IoT)
- Ultra low-cost tooling



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## Electropolishing





## **Room Temperature Nanocoating**





## **Internet of Things**





### **Glass Micromachining**





## **Applications**

#### MedTech



- Lab-On-Chip
- Multilayer chips
- Micro- to Macro-world interfaces
- Micro-cutting

#### Watch Industry



- Watchglass cutting
- Inner parts
- Anti-counterfeiting marks
- Localized glass strengthening

#### Consumer Electronics



- Drilling for Trough Glass Vias
- Micro-cutting of glass including thin (<300μm)</li>
- Micro-cutting of hardened glass

#### Rapid Prototyping



- Industrial R&D
- Fundamental Research
- Surface engineering
- Batch Size 1 production



## **SACE** Principle



#### Machinable materials



### **Flexible Machining**



## **Machining Specifications**

Drilling	<ul> <li>150 µm &lt; Ø &lt; ∞</li> <li>0 &lt; depth &lt; several mm</li> <li>1-5 s down to 700 µm</li> <li>vertical to tapered holes (0 to 90°)</li> <li>aspect ratio 1:10</li> </ul>
Milling	<ul> <li>20 mm/min at 200 µm depth of cut</li> <li>several mm deep</li> <li>tolerances on channel width: 5 %</li> <li>aspect ratio 1:10</li> </ul>
Micro-cutting	<ul> <li>10 - 20 mm/min</li> <li>depth: 4 - 5 mm</li> </ul>
Polishing	<ul> <li>Very rough to very smooth surfaces are possible</li> </ul>
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## Micro-drilling of glass







1mm deep 1:5

## **Micro-milling of glass**



### 2.5D machining of glass



Vac-High PC-Std. 10 kV x 130 \_\_\_\_\_ 200 μm 001331 Grid out N°12



# **SACE polishing (SACP)**

#### Glass thickness: 500 µm



## **SACE polishing (SACP)**





#### **Idea-to-realization**



## **Microfluidic for Medical Applications**





## **Direct glass-to-glass bonding**







#### Acoustic Microscope (Sonoscan®)

- Non-destructive testing
- Monitoring defects (e.g. voids, cracks)

#### ➡ No defects



### **Microfluidic Connection**







### **Industrial Production**



SWISS MADE



## **Current industrial partners**













Shilps Sciences















### What we offer



### THANK YOU





Electrochemical Green Engineering Group http://ege.encs.concordia.ca

